	<u>SPEC No. MS - J 0 8 X 0 4</u> ISSUE: Oct. 18. 1996
Το;	
SPECIF	PRELIMINARY
Product Type 256	k SRAM
LH52CV25	6 H T - 1 0 L L
Model No. (LH	5 2 C 5 V 1)
If you have any objections, please CUSTOMERS ACCEPTANCE DATE:	e contact us before issuing purchasing order.
PRS	SENTED
BAY:	T. KUZUMOTO Dept. General Manager
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 - Machine tools
 - Audiovisual equipment
 - Home appliances
 - · Communication equipment other than for trunk lines
 - (2) Those contemplating using the products covered herein for the following equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-sale operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.
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 - · Mainframe computers
 - · Traffic control systems
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 - · Communications equipment for trunk lines
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Please direct all queries regarding the products covered herein to a sales representative of the company.

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1. Description

The LH52CV256HT-10LL is a static RAM organized as 32.768×8 bit with provides low-power standby mode. It is fabricated using silicon-gate CMOS process technology.

Features

reatures				
OAccess Time			ns (Max.	
O0perating current	• • • •		nA (Max.	
	• • • •			$t = t wc = 1 \mu s$
OStandby current			A (Max.	
\bigcirc Data retention current				$V_{COR} = 3.0 V, Ta = 2.5 °C)$
OSingle power supply	• • • •	2.7V to 3		
O0perating temperature		-40℃ to +	+85℃	
OFully static operation				
OThree-state output				
ONot designed or rated a	as radiation harde	ned		-
\bigcirc 2 8 pin TSOP (TS	SOP 2 8 - P - 0	813) plastic	package	
ON-type bulk silicon				
2. Pin Configuration				
OE [1	.0			28 A 10
A 11 🛄 2				$\begin{array}{c cccc} 27 & \square & \overline{CE} \\ 26 & \square & I / O_8 \end{array}$
$\begin{array}{ccc} A_9 & \square & 3 \\ A_8 & \square & 4 \end{array}$				$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$				$\frac{1}{24} \square I / O_6$
$\frac{110}{WE}$ \Box 6	5			23 🔲 I/O 5
$V_{cc} \square 7$		(Top View)		$\begin{array}{c c} 22 & \square & I/O_4 \\ 21 & \square & GND \end{array}$
$\begin{array}{c c} A_{14} & \square & 8\\ A_{12} & \square & 9 \end{array}$		(Top view)		$\begin{array}{ccc} 21 & \Box & G N D \\ 20 & \Box & I / O 3 \end{array}$
$\begin{array}{c c} A_{12} & \Box & 9 \\ A_{7} & \Box & 1 \end{array}$				$\frac{1}{19} \square I/O_2$
A 6 🖂 1				18 🖂 I/O 1
A 5 🖂 🗓				$\begin{array}{c c} 17 & \square & A & 0 \\ 16 & \square & A & 1 \end{array}$
$\begin{array}{ccc} A_{4} & \square & 13 \\ A_{3} & \square & 14 \end{array}$				$ \begin{array}{cccccccccccccccccccccccccccccccccccc$
A 31	·			F ** *
[Pin Name	Function]
	Ao to A14	Address inputs		
	CE	Chip enable		
	WE	Write enable		
	<u> </u>	Output enable	··· ·· ·· ·· ·· ·· ·· ·· ·· ·· ·· ·· ··	

Power supply

Ground

I/OitoI/Os

Vcc

 $G \mathrel{\rm N} D$

Data inputs/outputs

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3. Truth Table

CE	WE	ΟE	Mode	I/O:toI/Os Supply current
Н	*	*	Standby	High impedance Standby (I 😔
L	H	L	Read	Data output 🕜 Active (I 🚌
L	Н	Н	Output disable	High impedance Active (I
L	L	*	Write	Data Input Active (I

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(*****=Don't Care, L=Low, H=High)



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5. Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Supply voltage (*1)	Vcc	-0.5 to $+7.0$	i v
Input voltage(*1)	VIN	-0.5(*2) to Vcc+0.3	V
Operating temperature	T _{ap} .	-40 to +85	Ĉ
Storage temperature	Tsig	-65 to $+150$	Ĉ

Note) *1. The maximum applicable voltage on any pin with respect to GND. *2.Undershoot of -3.0V is allowed width of pluse bellow 50ns.

6. Recommended DC Operating Conditions

(Ta = -40°C to +85°C)

			(I a	1001000	00/
Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	Vcc	2.7	3.0	3.6	V
Input voltage	V I H	2.2		$Vcc \div 0.3$	V
	V I L	-0.3 (*3)		0.4	V

Note) *3. Undershoot of -3.0V is allowed width of pluse below 50ns. .

7. DC Electrical Characteristics

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 $(T_a = -40$ °C to +85 °C, Vcc = 2.7 V to 3.6 V)

Parameter	Symbol	Conditions	Min.	Typ. (*4)	Max.	Unit
Input leakage	ILI	V _{IX} =OV to V _{cc}				
current			-1.0		1.0	μΑ
Output	ILO	CE =Viii or				
leakage		$\overline{OE} = V_{BI}$	-1.0		1.0	μΑ
current		V _{L/0} =OV to Vcc				
Operating	Icc	Minimum cycle				
supply		$V_{IN} = V_{IL}$ or V_{IH} , $I_{I/0} = OmA$, $\overline{CE} = V_{IL}$		10	15	mA
current		tre, the =1 μ s				
		$V_{IN} = V_{IL}$ or V_{IH} , $I_{I/0} = OmA$, $\overline{CE} = V_{IL}$			5	mA
Standby	Іѕв	$\overline{CE} \geq V_{ee} - 0.2V$		0.3	25	μΑ
current	Ізві	CE =V _{1H}			2	mA
Output	Vol	$I_{\text{OL}} = 0.5 \text{mA}$			0.4	V
voltage	Vон	$I_{OH} = -0.5 mA$	2.4			V

Note) *4. Typical values at Vcc=3.0V, Ta=25°C.

8. AC Electrical Characteristics

AC Test Conditions

Input pulse level	0.4V to 2.2V	
Input rise and fall time	5 n s	
Input and Output timing Ref. level	1.5V	
Output lead	C _L (100pF)	(*5)

Note) *5. Including scope and jig capacitance.

Read cycle

 $(T_a = -40$ °C to +85 °C, Vcc = 2.7 V to 3.6 V)

Parameter	Symbol	Min.	Max.	Unit	
Read cycle time	trc	100		ns	1
Address access time	t AA		100	ns	
CE access time	t ace		100	ns	
Output enable to output valid	toe		6 0	ns	
Output hold from address change	tон	15		ns]
CE Low to output active	tız	15		ns]
OE Low to output active .	toiz	5		ns	
CE High to output in High impedance	tнz	0	35	ns]
OE High to output in High impedance	tohz	0	3 5	ns	

Write cycle

(Ta = $-\;4\;0\;\mbox{\sc c}$ to $+\;8\;5\;\mbox{\sc c}$,Vcc = 2.7 V to 3.6 V)

Parameter	Symbol	Min.	Max.	Unit
Write cycle time	twc	100		ns
CE Low to end of write	tcw	80		ns
Address valid to end of write	taw	80		ns
Address setup time	t a s	0		ns
Write pluse width	twp	75		ns
Write recovery time	twr	0		ns
Input data setup time	tow	40		ns
Input data hold time	tон	0		ns
WE High to output active	tow	5		ns
WE Low to output in High impedance	t w z	0	35	ns
OE High to output in High impedance	toHz	0	3 5	ns

Note) *6. Active output to High impedance and High impedance to output active tests specified for a ±200mV transition from steady state levels into the test load.

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9. Data Retention Characteristics $(T_a = -4 \ 0 \ C \ to \ + 8 \ 5 \ C)$ Min. Typ. (*7) Max. Symbol Conditions Unit Paramenter VCCDR $\overline{CE} \ge VCCDR - 0.2V$ Data Retention V 2.0 3.6 supply voltage I CCDR | V CCDR = 3 VT a = 25 CData Retention 1.0 μA 0.3 T a = 7 0 ℃ μΑ 15 supply current $\overline{CE} \ge V \text{ccdr} - 0.2 \text{ V}$ 20 μA Chip enable tcdr 0 setup time n s Chip enable tr 5 m s hold time

Note) * 7. Typical values at Ta=25°C

10. Pin Capacitance

$(T_a = 25$ °C, f = 1 M H z)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	
Input capacitance	CIN	$V_{IN} = 0 V$	ļ		8	рF	* 8
I/O capacitance	C1/0	$V_{I/O} = 0 V$			10	рF	*8

Note) *8. This parameter is sampled and not production tested.

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STATIC SRAM RAM Random Access Memory 3V TSOP Industrial Temp LowVoltage Low Power LH52CV256HT10LL 256K